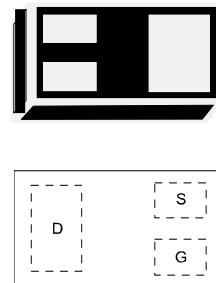
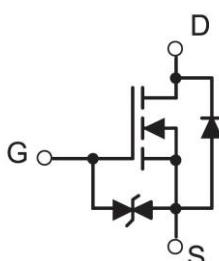


**20V N-Channel MOSFET****Features**

- Surface Mount Package
- N-Channel Switch with Low  $R_{DS(on)}$
- Operated at Low Logic Level Gate Drive
- ESD Protected

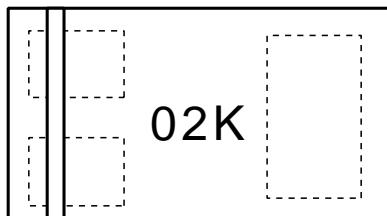
**Application**

- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift

**Package and Pin Configuration**

Circuit diagram

DFN1006-3L

**Marking Information**

02K = Device Marking Code

**MOSFET Product Summary**

$V_{DSS}$	$R_{DS(ON)} \text{ Max}$	$I_D$
20V	380mΩ @ $V_{GS}=4.5V$	0.75A
	450mΩ @ $V_{GS}=2.5V$	
	800mΩ @ $V_{GS}=1.8V$	

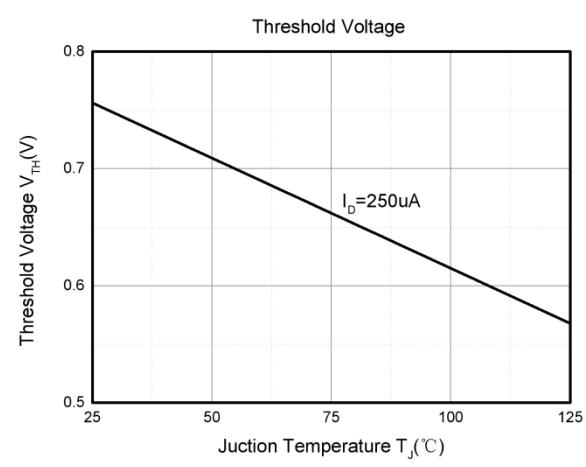
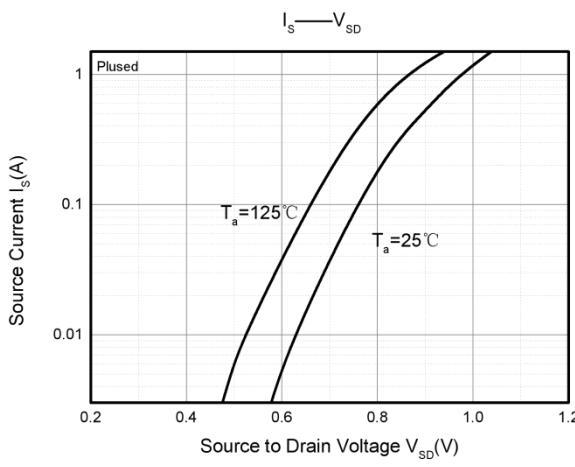
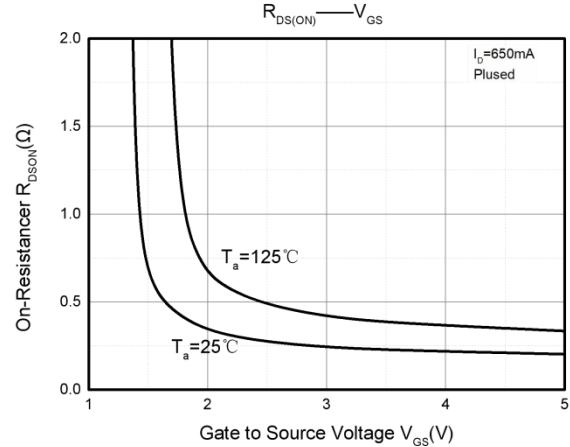
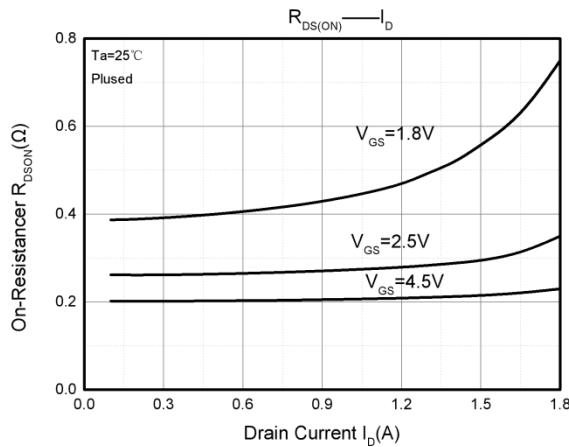
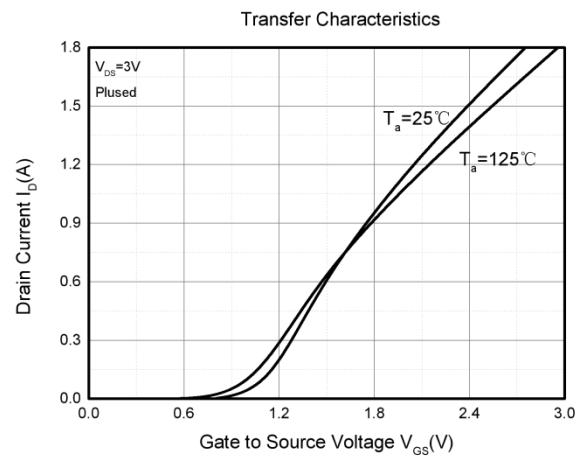
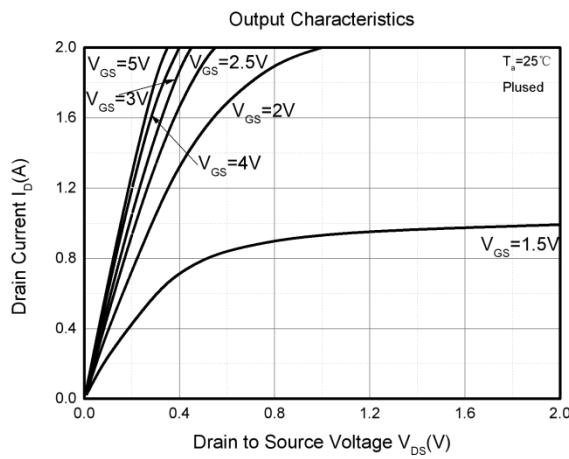
**Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

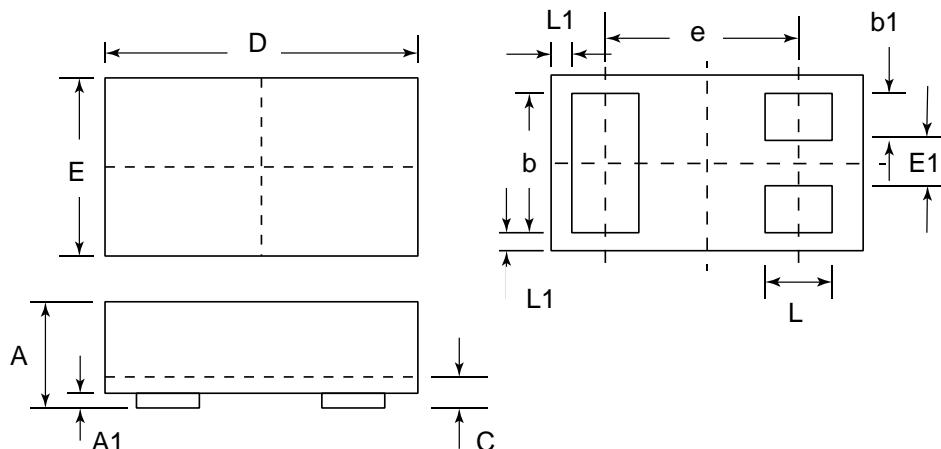
Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 10$	V
Continuous Drain Current	$I_D$	0.75	A
Pulsed Drain Current	$I_{DM}$	0.18	A
Power Dissipation	$P_D$	0.15	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	833	°C/W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55~+150	°C

**Electrical Characteristics (  $T_A = 25^\circ\text{C}$  unless otherwise noted )**

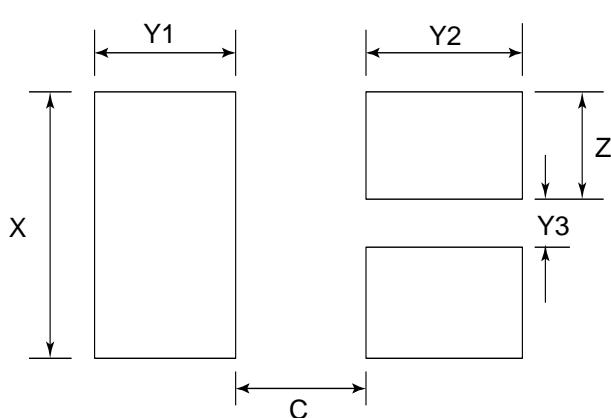
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	20			V
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{DS} = 16V, V_{GS} = 0V$			1	$\mu\text{A}$
Gate-body leakage current	$I_{\text{GSS}}$	$V_{GS} = \pm 8V, V_{DS} = 0V$			$\pm 10$	$\mu\text{A}$
Gate threshold voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.3	0.65	1	V
Drain-source on-resistance	$R_{DS(\text{on})}$	$V_{GS} = 4.5V, I_D = 0.5A$		0.25	0.38	$\Omega$
		$V_{GS} = 2.5V, I_D = 0.5A$		0.35	0.45	
		$V_{GS} = 1.8V, I_D = 0.5A$		0.4	0.8	
		$V_{GS} = 1.5V, I_D = 0.5A$		0.5		
		$V_{GS} = 1.2V, I_D = 0.5A$		1		
<b>Dynamic characteristics</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{DS} = 16V, V_{GS} = 0V, f = 1\text{MHz}$		79	120	pF
Output Capacitance	$C_{\text{oss}}$			13	20	
Reverse Transfer Capacitance	$C_{\text{rss}}$			9	15	
<b>Switching Characteristics</b>						
Turn-on delay time	$t_{d(on)}$	$V_{GS} = 4.5V, V_{DS} = 10V, I_D = 500\text{mA}, R_{\text{GEN}} = 10\Omega$		6.7		ns
Turn-on rise time	$t_r$			4.8		
Turn-off delay time	$t_{d(off)}$			17.3		
Turn-off fall time	$t_f$			7.4		
<b>Source-Drain Diode characteristics</b>						
Body Diode Voltage	$V_{SD}$	$I_S = 0.5\text{A}, V_{GS} = 0V$		0.7	1.3	V

## Typical Characteristics



DFN1006-3L Package Outline Drawing

SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.45	0.50	0.55	0.018	0.020	0.022
A1	0.00	0.02	0.05	0.000	0.001	0.002
b	0.45	0.50	0.55	0.018	0.020	0.022
b1	0.10	0.15	0.20	0.004	0.006	0.008
C	0.12	0.15	0.18	0.005	0.006	0.007
D	0.95	1.00	1.05	0.037	0.039	0.041
e	0.65 BSC			0.026 BSC		
E	0.55	0.60	0.65	0.022	0.024	0.026
E1	0.15	0.20	0.25	0.006	0.008	0.010
L	0.20	0.25	0.30	0.008	0.010	0.012
L1	0.05 REF			0.0002 REF		

Suggested Land Pattern

SYM	DIMENSIONS	
	MILLIMETERS	INCHES
C	0.25	0.010
X	0.65	0.024
Y1	0.50	0.020
Y2	0.50	0.020
Y3	0.25	0.010
Z	0.20	0.008